

APPLICATION DATA SHEET

APPLICATION INFORMATION

Application Type::	REGULAR
Subject Matter::	UTILITY
CD-ROM or CD-R?::	NONE
Title::	WAFER PROCESSING APPARATUS HAVING WAFER MAPPING FUNCTION
Attorney Docket Number::	245436US2
Total Drawing Sheets::	11
Small Entity?::	NO

INVENTOR INFORMATION

Applicant Authority Type::	INVENTOR
Primary Citizenship Country::	Japan
Status::	FULL CAPACITY
Given Name::	Jun
Family Name::	EMOTO
Street of Mailing Address::	c/o TDK CORPORATION 1-13-1, Nihonbashi, Chuo-ku,
City of Mailing Address::	Tokyo
Country of Mailing Address::	Japan
Postal or Zip Code of Mailing Address::	103-8272

Applicant Authority Type::	INVENTOR
Primary Citizenship Country::	Japan
Status::	FULL CAPACITY
Given Name::	Takeshi
Family Name::	KAGAYA
Street of Mailing Address::	c/o TDK CORPORATION 1-13-1, Nihonbashi, Chuo-ku,
City of Mailing Address::	Tokyo
Country of Mailing Address::	Japan
Postal or Zip Code of Mailing Address::	103-8272

Applicant Authority Type:: INVENTOR
Primary Citizenship Country:: Japan
Status:: FULL CAPACITY
Given Name:: Kazuo
Family Name:: YAMAZAKI
Street of Mailing Address:: c/o TDK CORPORATION
1-13-1, Nihonbashi, Chuo-ku,
City of Mailing Address:: Tokyo
Country of Mailing Address:: Japan
Postal or Zip Code of Mailing Address:: 103-8272

CORRESPONDENCE INFORMATION

Correspondence Customer Number:: 22850

REPRESENTATIVE INFORMATION

Representative Customer Number:: 22850

FOREIGN PRIORITY INFORMATION

Application Number:	Country::	Filing Date::	Priority Claimed::
2002-331868	Japan	11/15/02	YES

ASSIGNMENT INFORMATION

Assignee Name:: TDK CORPORATION
Street of Mailing Address:: 1-13-1, Nihonbashi, Chuo-ku,
City of Mailing Address:: Tokyo
Country of Mailing Address:: Japan
Postal or Zip Code of Mailing Address:: 103-8272